



## 20V N-Channel Trench Power MOSFET

### General Description

The SJS2302 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a wide variety of applications.

### Features

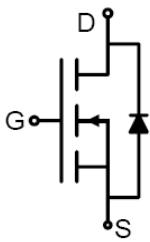
- Low Gate Charge
- High Power and current handing capability
- Lead free product is acquired

### Application

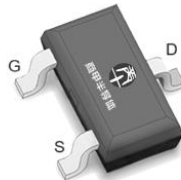
- PWM Applications
- Load Switch
- Power Management

### Key Performance Parametes

Parameter	Value	Unit
$V_{DS}$	20	V
$R_{DS(ON\_TYP)}$	48.6	mΩ
$I_D$	3.1	A
$Q_G$	3	nC



Schematic Diagram



SOT-23 view



### Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJS2302	2302	SOT-23	Tape	\	\	3000 Pcs

Table 1. Absolute Maximum Ratings ( $T_A=25^{\circ}\text{C}$  unless otherwise noted)

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0\text{V}$ )	20	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0\text{V}$ )	$\pm 12$	V
$I_D$	Drain Current-Continuous( $T_A=25^{\circ}\text{C}$ )	3.1	A
	Drain Current-Continuous( $T_A=100^{\circ}\text{C}$ )	2	A
$I_{DM}(\text{pluse})$	Drain Current-Continuous@ Current-Pulsed (Note 1)	12.4	A
$P_D$	Maximum Power Dissipation( $T_A=25^{\circ}\text{C}$ )	0.96	W
	Maximum Power Dissipation( $T_A=100^{\circ}\text{C}$ )	0.4	W
$E_{AS}$	Avalanche energy (Note 2)	4	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	$^{\circ}\text{C}$

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to- Ambient		140	$^{\circ}\text{C/W}$



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**Table 3. Electrical Characteristics ( $T_J=25^{\circ}\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	20			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =20V, V <sub>GS</sub> =0V T <sub>J</sub> =25℃			1	μA
		V <sub>DS</sub> =20V, V <sub>GS</sub> =0V T <sub>J</sub> =125℃			100	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±12V, V <sub>DS</sub> =0V			±100	uA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	0.45		1	V
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =4.5V, I <sub>D</sub> =1.5A		5.2		S
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =4.5V, I <sub>D</sub> =1.5A T <sub>J</sub> =25℃		46.8	63.2	mΩ
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance	V <sub>GS</sub> =2.5V, I <sub>D</sub> =1A T <sub>J</sub> =25℃		61.5	81.8	mΩ
Dynamic Characteristics						
C <sub>iSS</sub>	Input Capacitance	V <sub>DS</sub> =10V,V <sub>GS</sub> =0V, f=1.0KHz		186		pF
C <sub>oSS</sub>	Output Capacitance			30		pF
C <sub>rSS</sub>	Reverse Transfer Capacitance			23		pF
R <sub>g</sub>	Gate resistance	V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz		9.3		Ω
Switching Parameters						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =10V, R <sub>L</sub> =6.7Ω, R <sub>GEN</sub> =3Ω		3		nS
t <sub>r</sub>	Turn-on Rise Time			11		nS
t <sub>d(off)</sub>	Turn-Off Delay Time			20		nS
t <sub>f</sub>	Turn-Off Fall Time			8		nS
Q <sub>g</sub>	Total Gate Charge	V <sub>GS</sub> =4.5V, V <sub>DS</sub> =10V, I <sub>D</sub> =1.5A		3		nC
Q <sub>gs</sub>	Gate-Source Charge			0.5		nC
Q <sub>gd</sub>	Gate-Drain Charge			0.7		nC
Source-Drain Diode Characteristics						
I <sub>SD</sub>	Source-Drain Current (Body Diode)				3.1	A
V <sub>SD</sub>	Forward on Voltage (Note 3)	V <sub>GS</sub> =0V, I <sub>S</sub> =1.5A			1.2	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> =1.5A, dI/dt=100A/μs		4.3		ns
Q <sub>rr</sub>	Reverse Recovery Charge	I <sub>F</sub> =1.5A, dI/dt=100A/μs		0.6		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

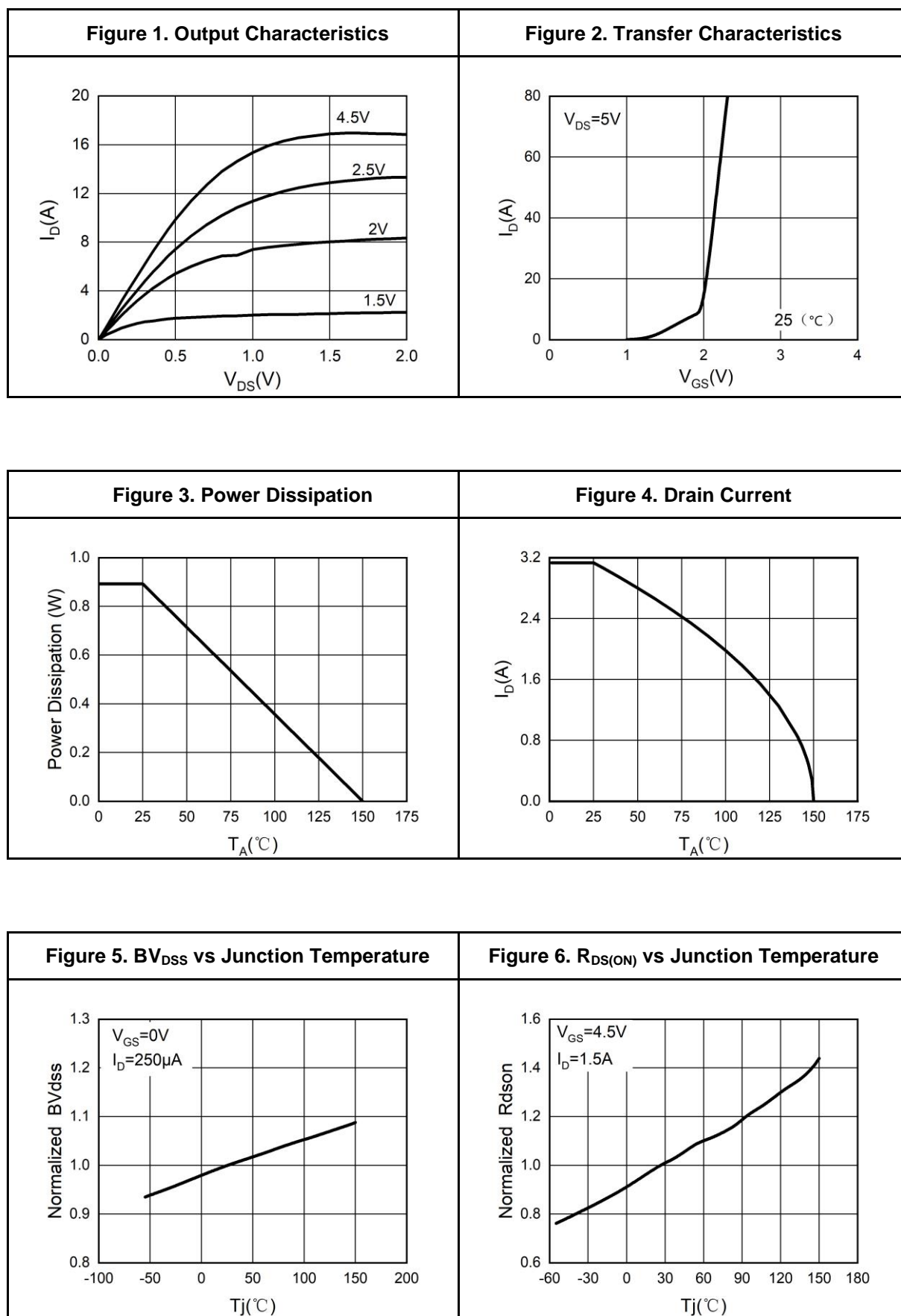
Notes 2.EAS condition:  $T_J=25^{\circ}\text{C}, V_{DD}=10V, V_G=10V, R_g=25\Omega, L=0.5mH$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



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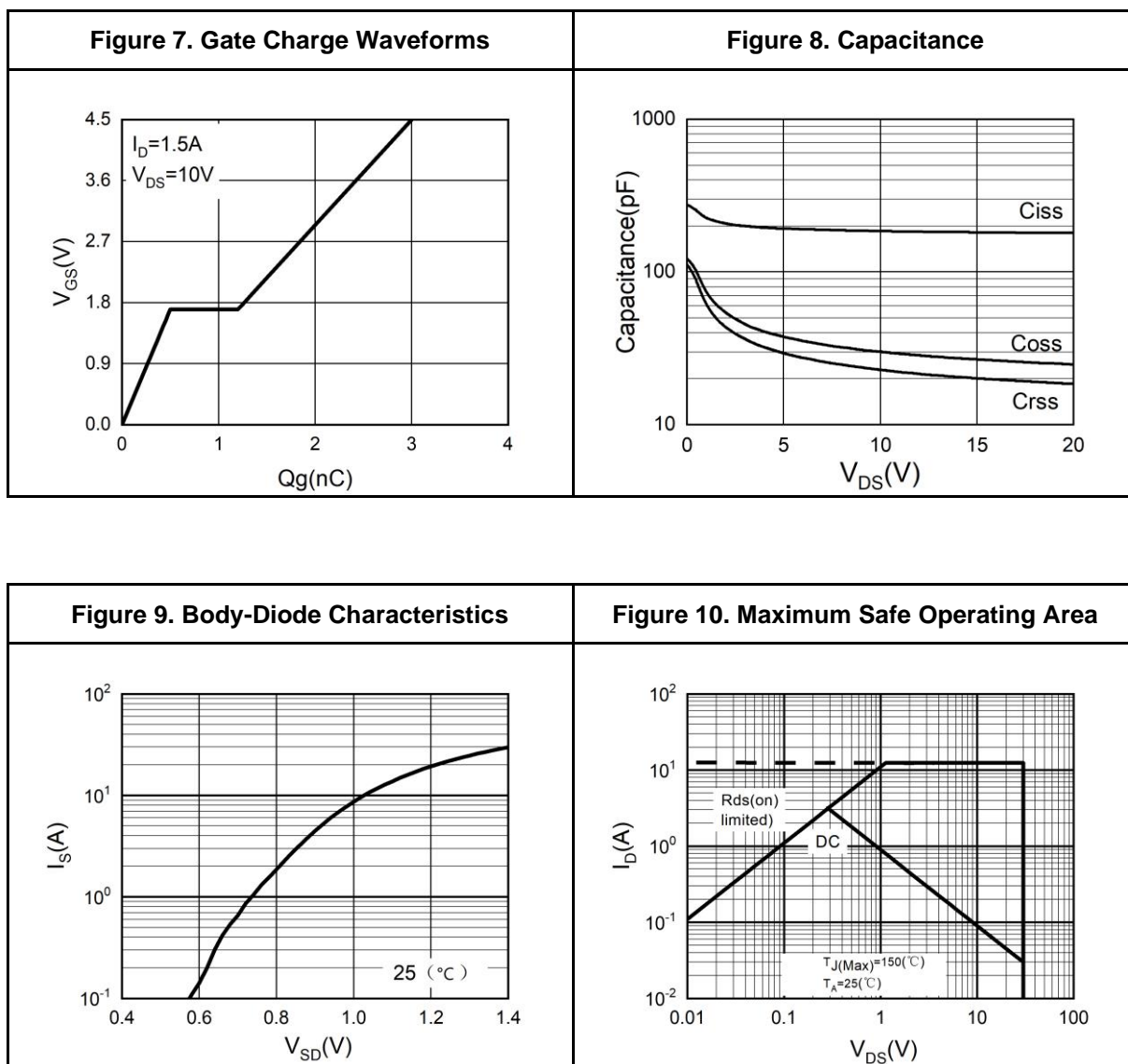
### Typical Electrical And Thermal Characteristics (Curves)





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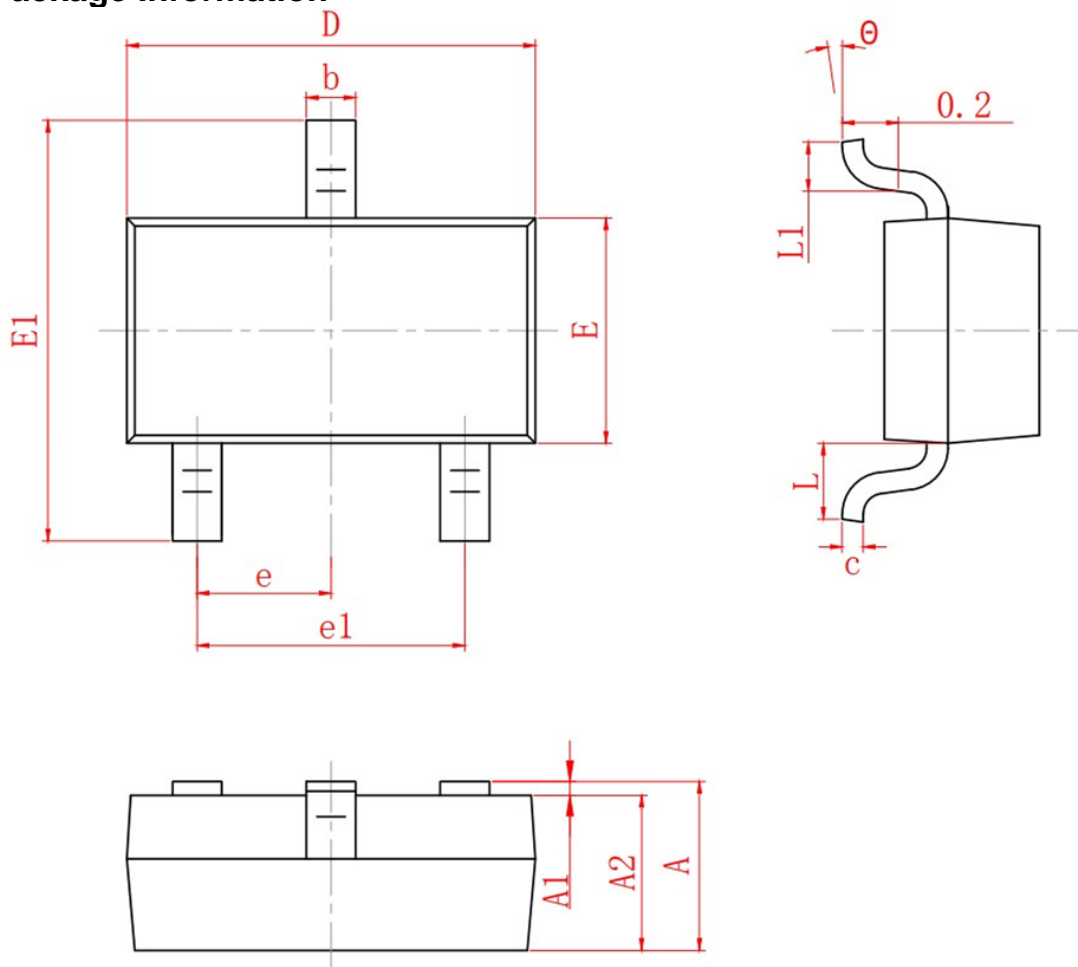
### Typical Electrical And Thermal Characteristics (Curves)





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### SOT-23 Package Information



SYMBOL	MIN	NOM	MAX
A	0.90	1.05	1.20
A1	0.00	0.05	0.10
A2	0.90	1.00	1.10
b	0.30	0.40	0.50
c	0.08	0.10	0.15
D	2.80	2.90	3.00
E	1.20	1.30	1.40
E1	2.30	2.40	2.50
L	0.30	0.40	0.50
$\theta$	0°	5°	10°
L1	0.55 REF		
e	0.95 BSC		
e1	1.90 REF		



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